

## Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

Supplier	User Part Number				
Nexperia B.V.	BZT52-B36				
Name of Laboratory	Part Description				
Assembly reliability labs	Nexperia DHAM	Zener			
	SMD package				
Based on AEC-Q101 Test	Test Conditions	Duration	# Lots	# Quantity	# Rejects
# E1	<b>TEST</b> Pre- and Post-Stress Electrical Test Tamb = 25 °C	N/A	see below	all parts	see below
# A1	<b>PC</b> Preconditioning JESD22-A113 Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85% Reflow soldering	24 hours 168 hours 3 cycles	810	58300	0
# B1	<b>HTRB</b> High Temperature Reverse Bias MIL-STD-750-1 M1038 Method A Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage	1000 hours	138	11040	0
# B1b	<b>SSOP</b> Steady State Operational MIL-STD-750-1 M1038 Method B Tj = Tjmax, Iz = 100% of max. datasheet reverse current	1000 hours	20	1600	0
# A4	<b>TC</b> Temperature Cycling JESD22-A104 -65 °C to Tjmax, not to exceed 150°C	1000 cycles	170	13600	0
# A3 alt	<b>AC</b> Autoclave JESD22-A102 Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia)	96 hours	170	13600	0
# A2 alt	<b>H3TRB</b> High Humidity High Temperature Reverse Bias JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of rated reverse voltage <sup>[1]</sup>	1000 hours	170	13600	0
# A5	<b>IOL</b> Intermittent Operating Life MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔTj = 100 °C for 15000 cycles	1000 hours	170	13600	0
# C8	<b>RSH</b> Resistance to Solder Heat JESD22-A111 260 °C ± 5 °C	10 s	130	3900	0
# C10	<b>SD</b> Solderability J-STD-002		363	3630	0

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

### Calculation of FIT and MTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia DHAM	Zener	11040	0	0.38	2.60E+09

© 2022 Nexperia B.V.

All information hereunder is per Nexperia's best knowledge. This document does not provide for any representation or warranty express or implied by Nexperia. In case Nexperia has tested the product, this documentation reflects the outcome of the analysis of the actually tested parts only.

[nexperia.com](http://nexperia.com)